

Electronic Acknowledgement Receipt

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Application Number:	10811186
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Title of Invention:	Interconnect structure with dielectric barrier and fabrication method thereof
First Named Inventor:	Zhen-Cheng Wu
Customer Number:	47390
Filer:	Daniel R. McClure
Filer Authorized By:	
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Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Amendment - After Non-Final Rejection	00412272.pdf	159544	no	14

Warnings:	
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Total Files Size (in bytes):	159544
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